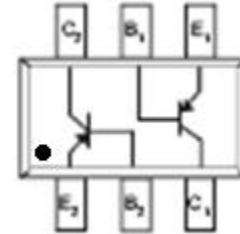




### FEATURES

- Epitaxial planar die construction.
- Complementary NPN type available MMDT2222A.
- Ultra-small surface mount package.



### APPLICATIONS

- For Low power amplification and switching.

**SOT-363**

### ORDERING INFORMATION

Type No.	Marking	Package Code
MMDT2907A	K2F	SOT-363

### MAXIMUM RATING @ Ta=25°C unless otherwise specified

Symbol	Parameter	Value	Unit
$V_{CBO}$	Collector-Base Voltage	-60	V
$V_{CEO}$	Collector-Emitter Voltage	-60	V
$V_{EBO}$	Emitter-Base Voltage	-5	V
$I_C$	Collector Current -Continuous	-600	mA
$P_D$	Power Dissipation	200	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	625	°C/W
$T_j, T_{stg}$	Junction and Storage Temperature	-55 to +150	°C



### ELECTRICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

Parameter	Symbol	Test conditions	MIN	MAX	UNIT
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C = -10\mu A$ $I_E = 0$	-60	-	V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C = -10mA$ $I_B = 0$	-60	-	V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E = -10\mu A$ $I_C = 0$	-5	-	V
Collector cut-off current	$I_{CBO}$	$V_{CB} = -50V$ $I_E = 0$ $V_{CB} = -50V$ $I_E = 0$ $T_A = 125^\circ C$	-	-10	nA $\mu A$
Collector cut-off current	$I_{CEX}$	$V_{CE} = -30V$ , $V_{EB(OFF)} = -0.5V$	-	-50	nA
Base cut-off current	$I_{BL}$	$V_{CE} = -30V$ , $V_{EB(OFF)} = -0.5V$	-	-50	nA
DC current gain	$h_{FE}$	$V_{CE} = -10V$ $I_C = -100\mu A$	75	-	-
		$V_{CE} = -10V$ $I_C = -1.0mA$	100	-	
		$V_{CE} = -10V$ $I_C = -10mA$	100	-	
		$V_{CE} = -10V$ $I_C = -150mA$	100	300	
		$V_{CE} = -10V$ $I_C = -500mA$	50	-	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = -150mA$ $I_B = -15mA$ $I_C = -500mA$ $I_B = -50mA$	-	-0.4 -1.6	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = -150mA$ $I_B = -15mA$ $I_C = -500mA$ $I_B = -50mA$	-	-1.3 -2.6	V
Transition frequency	$f_T$	$V_{CE} = -20V$ $I_C = -50mA$ $f = 100MHz$	200	-	MHz
Output Capacitance	$C_{obo}$	$V_{CB} = -10V$ , $f = 1.0MHz$ , $I_E = 0$	-	8	pF
Input Capacitance	$C_{ibo}$	$V_{EB} = -2.0V$ , $f = 1.0MHz$ , $I_C = 0$	-	30	pF
Turn-On Time	$t_{on}$	$V_{CC} = -30V$ , $I_C = -150mA$ , $I_{B1} = -15mA$	-	45	ns
Delay time	$t_d$		-	10	ns
Rise time	$t_r$		-	40	ns
Turn-Off Time	$T_{off}$		-	100	ns
Storage time	$t_s$	$V_{CC} = -6V$ , $I_C = -150mA$ $I_{B1} = -I_{B2} = -15mA$	-	225	ns
Fall time	$t_f$		-	60	ns

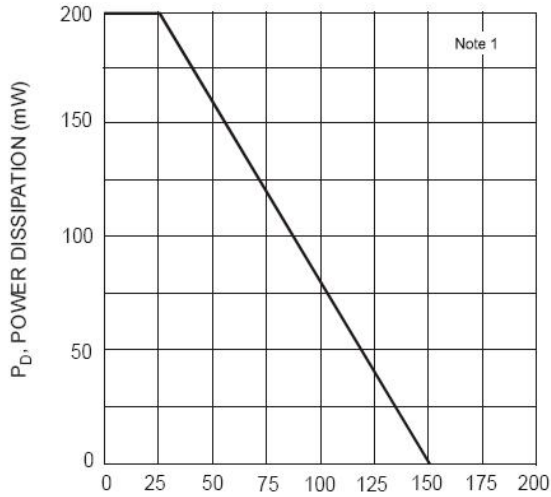


# MMDT2907A

## Dual Bipolar Transistor(PNP+PNP)



### TYPICAL CHARACTERISTICS @ $T_a=25^\circ\text{C}$ unless otherwise specified



$T_A$ , AMBIENT TEMPERATURE ( $^\circ\text{C}$ )  
Fig. 1, Max Power Dissipation vs. Ambient Temperature (Total Device)

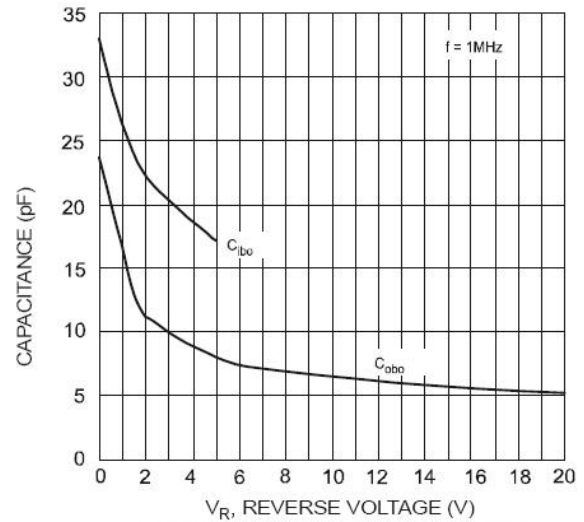


Fig. 2, Typical Capacitance Characteristics

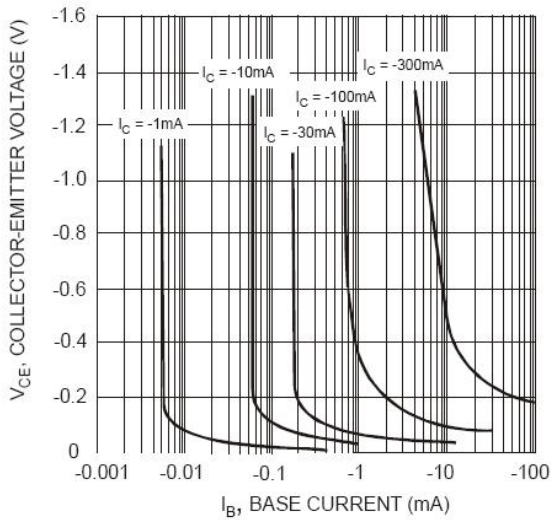


Fig. 3, Typical Collector Saturation Region

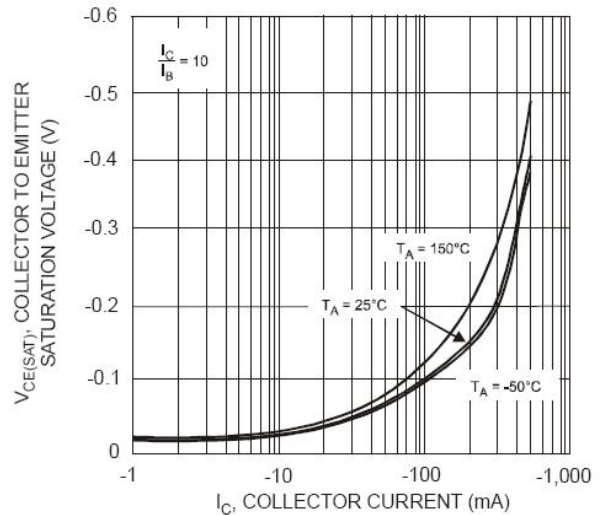


Fig. 4, Collector Emitter Saturation Voltage vs. Collector Current



# MMDT2907A

## Dual Bipolar Transistor(PNP+PNP)

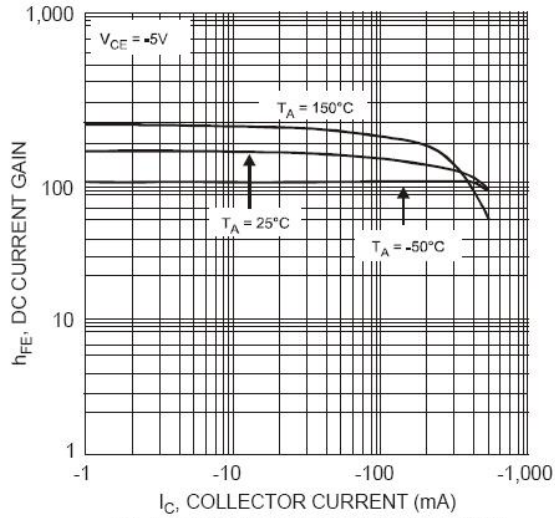


Fig. 5, DC Current Gain vs. Collector Current

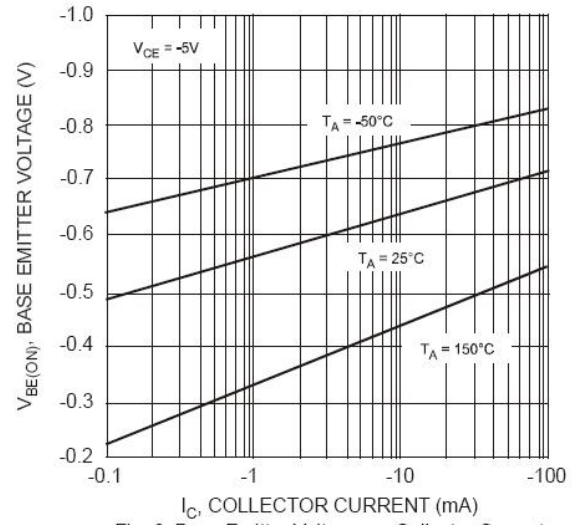


Fig. 6, Base Emitter Voltage vs. Collector Current

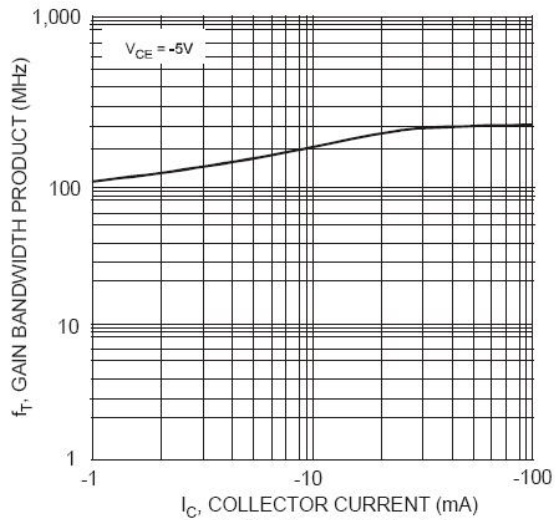
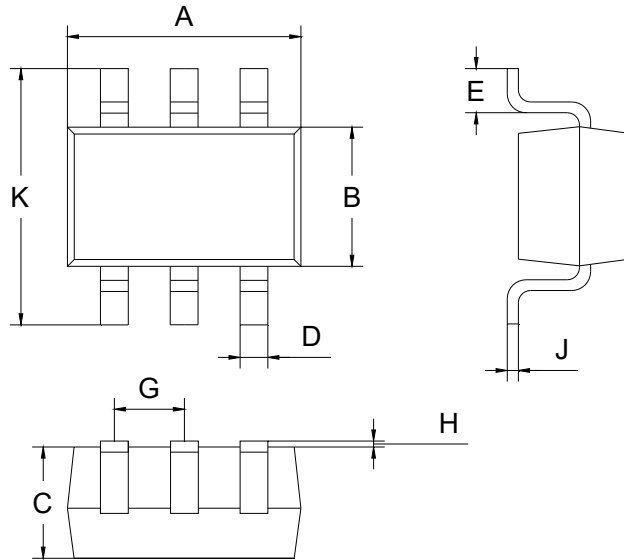


Fig. 7, Gain Bandwidth Product vs. Collector Current

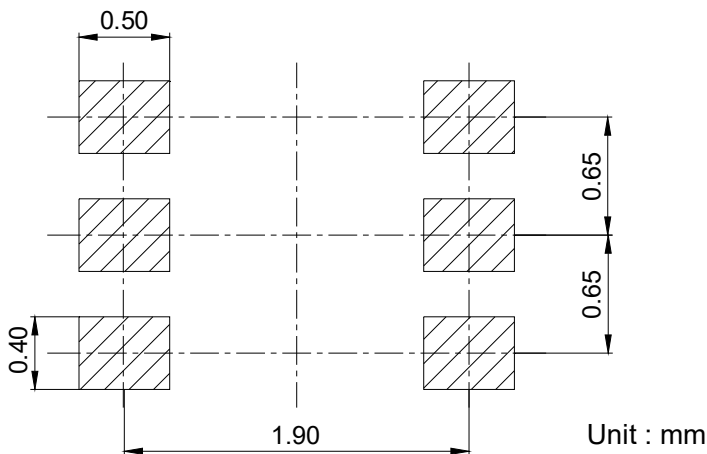
## PACKAGE OUTLINE

Plastic surface mounted package



SOT-363		
Dim	Min	Max
A	2.00	2.20
B	1.15	1.35
C	0.85	1.05
D	0.15	0.35
E	0.25	0.40
G	0.60	0.70
H	0.02	0.10
J	0.05	0.15
K	2.20	2.40
All Dimensions in mm		

## SOLDERING FOOTPRINT



## PACKAGE INFORMATION

Device	Package	Shipping
MMDT2907A	SOT-363	3000pcs / Tape & Reel